

# High Efficiency Linear Power Supply with Accurate Power Surveillance and Software Monitoring

### Features

- Highly accurate 5 V, 250 mA guaranteed output
- Low dropout voltage, typically 260 mV at 250 mA
- Low quiescent current, typically 175 µA
- Standby mode, maximum current 340 μA (with 100 μA load on OUTPUT)
- Unregulated DC input can withstand -20 V reverse battery and +60 V power transients
- Fully operational for unregulated DC input voltage up to 40 V and regulated output voltage down to 3.0 V
- Reset output guaranteed for regulated output voltage down to 1.2 V
- No reverse output current
- Very low temperature coefficient for the regulated output
- Current limiting
- Comparator for voltage monitoring, voltage reference 1.52 V
- Programmable reset voltage monitoring
- Programmable power on reset (POR) delay
- Watchdog with programmable time windows guarantees a minimum time and a maximum time between software clearing of the watchdog
- Time base accuracy ±10%
- System enable output offers added security
- TTL/CMOS compatible
- -40 to +125°C temperature range
- PSOP2-16 package

## Description

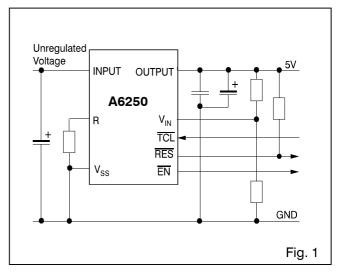
The A6250 offers a high level of integration by combining voltage regulation, voltage monitoring and software monitoring in a 16 lead package. The voltage regulator has a low dropout voltage (typ. 260 mV at 250 mA) and a low quiescent current (175  $\mu$ A). The quiescent current increases only slightly in dropout prolonging battery life. Built-in protection includes a positive transient absorber for up to 60 V (load dump) and the ability to survive an unregulated input voltage of -20 V (reverse battery). The input may be connected to ground or a reverse voltage without reverse current flow from the output to the input. A comparator monitors the voltage applied at the V<sub>IN</sub> input comparing it with an internal 1.52 V reference. The power-on reset function is initialized after V<sub>IN</sub> reaches 1.52 V and takes the reset output inactive after T<sub>POR</sub> depending of external resistance. The reset output goes active low when the  $V_{\mbox{\tiny IN}}$  voltage is less than 1.52 V. The RES and EN outputs are guaranteed to be in a correct state for a regulated output voltage as low as 1.2 V. The watchdog function monitors software cycle time and execution. If

software clears the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution) it will cause the system to be reset. The system enable output prevents critical control functions being activated until software has successfully cleared the watchdog three times. Such a security could be used to prevent motor controls being energized on repeated resets of a faulty system.

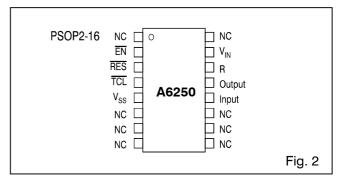
### Applications

- Industrial electronics
- Cellular telephones
- Security systems
- Battery powered products
- High efficiency linear power supplies
- Automotive electronics

## **Typical Operating Configuration**



### **Pin Assignment**





### **Absolute Maximum Ratings**

Symbol	Conditions
VINPUT	-0.3 to +45 V
VTRANS	up to +60 V
V <sub>REV</sub>	-20 V
V <sub>MAX</sub>	OUTPUT+0.3V
V <sub>MIN</sub>	V <sub>ss</sub> -0.3V
T <sub>STO</sub>	-65 to +150°C
TJ	max. 150 °C
V <sub>Smax</sub>	1000V
T <sub>Smax</sub>	250°C x 10 s
<b>I</b> OUTPUTmax	300 mA
	VINPUT VTRANS VREV VMAX VMIN TSTO TJ VSmax TSmax

Table 1

Stresses above these listed maximum ratings may cause permanent damage to the device. Exposure beyond specified operating conditions may affect device reliability or cause malfunction.

### **Decoupling Methods**

The input capacitor is necessary to compensate the line influences. A resistor of approx. 1 Ω connected in series with the input capacitor may be used to damp the oscillation of the input capacitor and input inductivity. The ESR value of the capacitor plays a major role regarding the efficiency of the decoupling. It is recommended also to connect a ceramic capacitor (100 nF) directly at the IC's pins. In general the user must assure that pulses on the input line have slew rates lower than 1 V/ $\mu$ s. On the output side, the capacitor is necessary for the stability of the regulation circuit. The stability is guaranteed for values of 22  $\mu$ F or bigger. It is specially important to choose a capacitor with a low ESR value. Tantal capacitors are recommended. See the notes related to Table 2. Special care must be taken in disturbed environments (automotive, proximity of motors and relays, etc.).

### **Handling Procedures**

This device has built-in protection against high static voltages or electric fields; however, anti-static precautions must be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept within the supply voltage range. Unused inputs must always be tied to a defined logic voltage level.

### **Operating Conditions**

Parameter	Symbol	Min.	Max.	Units
Operating junction temperature <sup>1)</sup> INPUT voltage <sup>2)</sup> OUTPUT voltage <sup>2) 3)</sup> RES & EN guaranteed <sup>4)</sup> OUTPUT current <sup>5)</sup>	T <sub>J</sub> VI <sub>NPUT</sub> Voutput Voutput Ioutput	-40 2.3 1.2 1.2	+125 40 250	°C V V V mA
Comparator input voltage RC-oscillator programming <sup>6)</sup> Thermal resistance from junction to ambient <sup>7)</sup> - PSOP2-16	V <sub>IN</sub> R R	0 10 30	V <sub>оитрит</sub> 1000 90	V kΩ °C/W

Table 2

<sup>1)</sup> The maximum operating temperature is confirmed by sampling at initial device qualification. In production, all devices are tested at +125°C.

 $^{2)}$  Full operation guaranteed. To achieve the load regulation specified in Table 3 a 22  $\mu$ F capacitor or greater is required on the INPUT, see Fig. 8. The 22  $\mu$ F must have an effective resistance  $\leq$  5  $\Omega$  and a resonant frequency above 500 kHz.

<sup>3)</sup> A 10 μF load capacitor and a 100 nF decoupling capacitor are required on the regulator OUTPUT for stability. The 10 μF must have an effective series resistance of  $\leq$  5 Ω and a resonant frequency above 500 kHz.

<sup>4)</sup> RES must be pulled up externally to V<sub>OUTPUT</sub> even if it is unused. (Note: RES and EN are used as inputs by EM test.)

<sup>5)</sup> The OUTPUT current will not apply for all possible combinations of input voltage and output current. Combinations that would require the A6250 to work above the maximum junction temperature (+125 °C) must be avoided.

 $^{6)}$  Resistor values close to 1000 k $\Omega$  are not recommended for applications working at 125 °C.

<sup>7)</sup> The thermal resistance specified assumes the package is soldered to a PCB. The termal resistance's value depends on the PCB's structure. A typical value of 51 °C/W has been obtained with a dual layer board, with the slug soldered to the heat-sink area of the PCB (see Fig. 22).



### **Electrical Characteristics**

 $V_{INPUT} = 6.0$  V,  $C_L = 10 \,\mu\text{F} + 100$  nF,  $C_{INPUT} = 22 \,\mu\text{F}$ ,  $T_J = -40$  to  $+125^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Supply current in standby mode	I <sub>SS</sub>	$R_{EXT} = don't care, TCL = V_{OUTPUT},$				
		$V_{IN} = 0 V, I_{L} = 100 \mu A$		140	340	μA
Supply current <sup>1)</sup>	I <sub>SS</sub>	$R_{EXT} = 100 \text{ k}\Omega, \text{ I/Ps at } V_{OUTPUT},$				
		O/Ps 1 M $\Omega$ to V <sub>OUTPUT</sub> , I <sub>L</sub> = 100 $\mu$ A		175	400	μA
Supply current <sup>1)</sup>	I <sub>ss</sub>	$R_{EXT} = 100 \text{ k}\Omega, \text{ I/Ps at } V_{OUTPUT},$				
		$V_{\text{INPUT}} = 8.0 \text{ V}, \text{ O/Ps 1}M\Omega \text{ to } V_{\text{OUTPUT}},$		17	4.0	
		$I_{L} = 100 \text{ mA}$ $I_{L} = 250 \text{ mA}$		1.7 7	4.2 15	mA mA
Output voltage	V	$I_{L} = 250 \text{ mA}$ $I_{1} = 100 \mu\text{A}$	4.85	/	5.15	V
Output voltage	V <sub>OUTPUT</sub> V <sub>OUTPUT</sub>	$I_{L} = 100 \mu\text{A}$ 100 $\mu\text{A} \le I_{L} \le 250 \text{mA}$ ,	4.85		5.15	v
Output voltage temperature	▼ OUTPUT	$100 \mu \Lambda \ge 1 \ge 200 \text{ mA},$	4.00		0.10	v
coefficient <sup>2)</sup>	$V_{\text{th(coeff)}}$			100		ppm/°C
Line regulation <sup>3)</sup>	V <sub>LINE</sub>	$6 \text{ V} \leq \text{V}_{\text{INPUT}} \leq 35 \text{ V}, \text{ I}_{\text{L}} = 1 \text{ mA},$				PP, •
<b>J</b>	LINE	$T_{J} = +125^{\circ}C$		0.2	0.8	%
Load regulation <sup>3)</sup>	VL	$100 \ \mu A \le I_{L} \le 100 \ mA$		0.2	0.7	%
Load regulation <sup>3)</sup>	V <sub>L</sub>	$5 \text{ mA} \leq I_{L} \leq 250 \text{ mA}$		0.9	1.45	%
Dropout voltage 4)	VDROPOUT	$I_L = 100 \mu\text{A}$		40	170	mV
Dropout voltage 4)	VDROPOUT	$I_L = 100 \text{ mA}$		160	380 <sup>5)</sup>	mV
Dropout voltage 4)	VDROPOUT	$I_L = 250 \text{ mA}$		260	650	mV
Dropout supply current	I <sub>ss</sub>	$V_{INPUT} = 4.5 \text{ V}, I_{L} = 100 \mu\text{A},$				
		$R_{EXT} = 100 \text{ k}\Omega, \text{ O/Ps 1 M}\Omega \text{ to}$				
		V <sub>OUTPUT</sub> , I/Ps at V <sub>OUTPUT</sub>		1.2	1.8	mA
Current limit	Lmax	OUTPUT tied to V <sub>ss</sub>		450		mA
OUTPUT noise, 10 Hz to 100 kHz	V <sub>NOISE</sub>			200		μV rms

 $4.5 \le V_{\text{OUTPUT}} \le 5.5 \text{ V}, \text{ I}_{\text{L}} = 100 \,\mu\text{A}. \text{ C}_{\text{L}} = 10 \,\mu\text{F} + 100 \text{ nF}, \text{ C}_{\text{INPUT}} = 22 \,\mu\text{F}, \text{ T}_{\text{J}} = -40 \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise specified}$ 

RES and EN						
Output Low Voltage	V <sub>OL</sub>	$V_{OUTPUT} = 4.5 \text{ V}, I_{OL} = 20 \text{ mA}$		0.4		V
	V <sub>OL</sub>	$V_{OUTPUT} = 4.5 \text{ V}, I_{OL} = 8 \text{ mA}$		0.2	0.4	V
	V <sub>OL</sub>	$V_{OUTPUT} = 2.0 \text{ V}, I_{OL} = 4 \text{ mA}$		0.2	0.4	V
	V <sub>OL</sub>	$V_{OUTPUT} = 1.2 \text{ V}, I_{OL} = 0.5 \text{ mA}$		0.06	0.2	V
EN						
Output High Voltage	V <sub>OH</sub>	$V_{OUTPUT} = 4.5 V, I_{OH} = -1 mA$	3.5	4.1		V
	V <sub>OH</sub>	$V_{OUTPUT} = 2.0 \text{ V}, I_{OH} = -100 \mu\text{A}$	1.8	1.9		V
	V <sub>OH</sub>	$V_{OUTPUT} = 1.2 \text{ V}, I_{OH} = -30 \mu\text{A}$	1.0	1.1		V
TCL and V <sub>IN</sub>						
TCL Input Low Level	VIL		V <sub>ss</sub>		0.8	V
TCL Input High Level	VIH		2.0		VOUTPUT	V
Leakage current TCL input	I <sub>U</sub>	$V_{SS} \leq V_{TCL} \leq V_{OUTPUT}$		0.05	1	μA
V <sub>IN</sub> input resistance	R <sub>VIN</sub>			100		MΩ
Comparator reference <sup>6) 7)</sup>	V <sub>REF</sub>	$T_{J} = +25^{\circ}C$	1.474	1.52	1.566	V
	V <sub>REF</sub>		1.436		1.620	V
	V <sub>REF</sub>	-40°C ≤ T <sub>J</sub> ≤ +125°C	1.420		1.620	V
Comparator hysteresis 7)	V <sub>HY</sub>	-		2		mV

Table 3

<sup>1)</sup> If INPUT is connected to V<sub>ss</sub>, no reverse current will flow from the OUTPUT to the INPUT, however the supply current specified will be sank by the OUTPUT to supply the A6250.

<sup>2)</sup> The OUTPUT voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
 <sup>3)</sup> Regulation is measured at constant junction temperature using pulse testing with a low duty cycle. Changes in OUTPUT voltage due to heating effects are covered in the specification for thermal regulation.

<sup>4)</sup> The dropout voltage is defined as the INPUT to OUTPUT differential, measured with the input voltage equal to 5.0 V.

<sup>5</sup>) Not tested.

<sup>6)</sup> The comparator and the voltage regulator have separate voltage references (see Block Diagram Fig. 7).

<sup>7)</sup> The comparator reference is the power-down reset threshold. The power-on reset threshold equals the comparator reference voltage plus the comparator hysteresis (see Fig. 4).

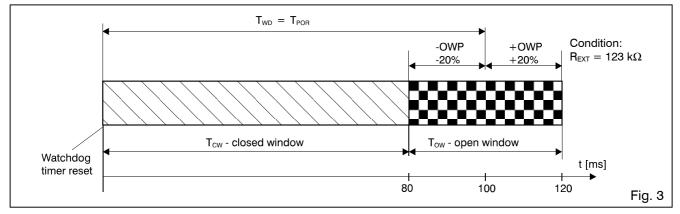


**Timing Characteristics**  $V_{INPUT} = 6.0 \text{ V}, I_L = 100 \ \mu\text{A}, C_L = 10 \ \mu\text{F} + 100 \ n\text{F}, C_{INPUT} = 22 \ \mu\text{F}, T_J = -40 \ to + 125^{\circ}\text{C}, unless otherwise specified$ 

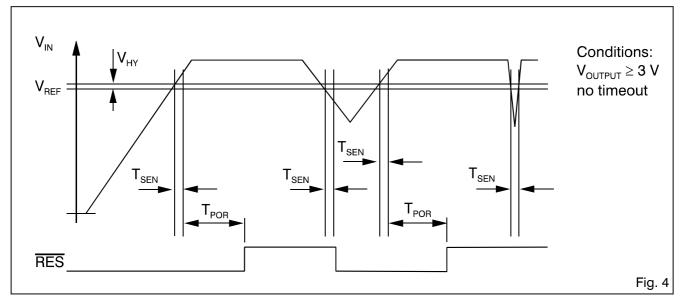
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Propagation delays:						
TCL to Output Pins	T <sub>DIDO</sub>			250	500	ns
V <sub>IN</sub> sensitivity	T <sub>SEN</sub>		1	5	20	μs
Logic Transition Times on all						
Output Pins	T <sub>TR</sub>	Load 10 kΩ, 50 pF		30	100	ns
Power-on Reset delay	T <sub>POB</sub>	$R_{FXT} = 123 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Watchdog Time	T <sub>WD</sub>	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	90	100	110	ms
Open Window Percentage	OWP			$\pm 0.2 T_{WD}$		
Closed Window Time	T <sub>cw</sub>			0.8 T <sub>WD</sub>		
	T <sub>cw</sub>	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$	72	80	88	ms
Open Window Time	Tow			0.4 T <sub>WD</sub>		
	Tow	$R_{FXT} = 123 \text{ k}\Omega, \pm 1\%$	36	40	44	ms
Watchdog Reset Pulse	T <sub>WDR</sub>			T <sub>WD</sub> / 40		
5	TWDR	$R_{EXT} = 123 \text{ k}\Omega, \pm 1\%$		2.5		ms
T <sub>CL</sub> Input Pulse Width	T <sub>TCL</sub>		150			ns
	-	·				Table

**Timing Waveforms** 

#### Watchdog Timeout Period

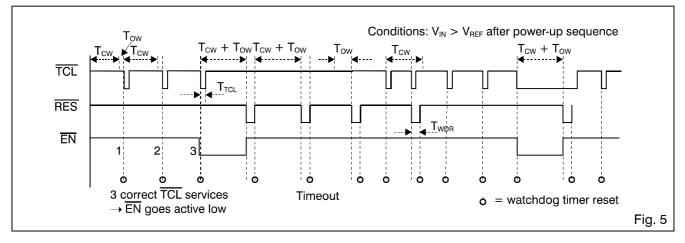


### Voltage Monitoring

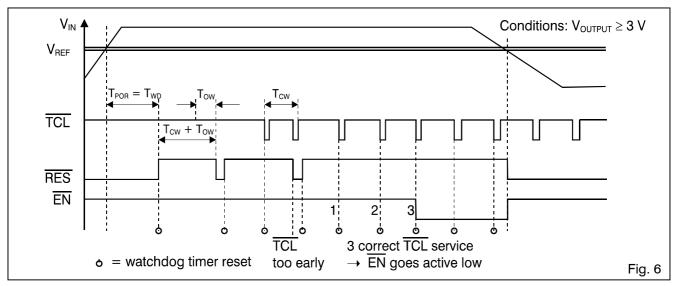




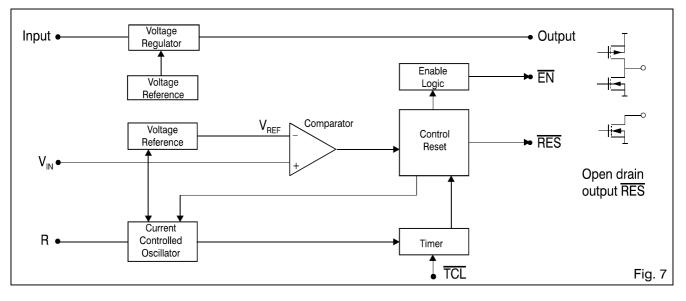
#### **Timer Reaction**



#### **Combined Voltage and Timer Reaction**



### **Block Diagram**





### **Pin Description**

Pin	Name	Function
2 3	EN RES	Push-pull active low enable output Open drain active low reset output. RES must be pulled up to V <sub>OUTPUT</sub> even if unused
4	TCL	Watchdog timer clear input signal
5	V <sub>ss</sub>	GND terminal
12	INPUT	Voltage regulator input
13	OUTPUT	Voltage regulator output
14	R	REXT input for RC oscillator tuning
15	V <sub>IN</sub>	Voltage comparator input

Table 5

### **Functional Description**

#### Voltage Regulator

The A6250 has a 5 V  $\pm$  3%, 250 mA, low dropout voltage regulator. The low supply current (typ. 175  $\mu$ A) makes the A6250 particularly suited to automotive systems then remain energized 24 hours a day. The input voltage range is 2.3 V to 40 V for operation and the input protection includes both reverse battery (20 V below ground) and load dump (positive transients up to 60 V). There is no reverse current flow from the OUTPUT to the INPUT when the INPUT equals V<sub>ss</sub>. This feature is important for systems which need to implement (with capacitance) a minimum power supply hold-up time in the event of power failure. To achieve good load regulation a 22 µF capacitor (or greater) is needed on the INPUT (see Fig. 8). Tantalum or aluminium electrolytics are adequate for the 22  $\mu$ F capacitor; film types will work but are relatively expensive. Many aluminium electrolytics have electrolytes that freeze at about -30°C, so tantalums are recommended for operation below -25°C. The important parameters of the 22  $\mu$ F capacitor are an effective series resistance of  $\leq$  5  $\Omega$  and a resonant frequency above 500 kHz.

A 10  $\mu$ F capacitor (or greater) and a 100 nF capacitor are required on the OUTPUT to prevent oscillations due to instability. The specification of the 10  $\mu$ F capacitor is as per the 22 µF capacitor on the INPUT (see previous paragraph).

The A6250 will remain stable and in regulation with no external load and the dropout voltage is typically constant as the input voltage fall to below its minimum level (see Table 2). These features are especially important in CMOS RAM keep-alive applications.

Care must be taken not to exceed the maximum junction temperature (+125°C). The power dissipation within the A6250 is given by the formula:

 $P_{TOTAL} = (V_{INPUT} - V_{OUTPUT}) \cdot I_{OUTPUT} + (V_{INPUT}) \cdot I_{SS}$ The maximum continuous power dissipation at a given temperature can be calculated using the formula:

 $P_{MAX} = (125^{\circ}C - T_A) / Rth(j-a)$ 

where Rth(j-a) is the thermal resistance from the junction to the ambient and is specified in Table 2. Note the R<sub>th(i-a)</sub> given in Table 2 assumes that the package is soldered to a PCB. The above formula for maximum power dissipation assumes a constant load (ie. ≥ 100 s). The transient thermal resistance for a single pulse is much lower than the continuous value.

### V<sub>IN</sub> Monitoring

The power-on reset and the power-down reset are generated as a response to the external voltage level on the V<sub>IN</sub> input. The external voltage level is typically obtained from a voltage divider as shown in Fig. 8. The user uses the external voltage divider to set the desired threshold level for power-on reset and power-down reset in his system. The internal comparator reference voltage is typically 1.52 V. At power-up the reset output ( $\overline{RES}$ ) is held low (see Fig. 4). After INPUT reaches 3.36 V (and so OUTPUT reaches at least 3 V) and  $V_{IN}$  becomes greater than  $V_{REP}$ , the RES output is held low for an additional power-on-reset (POR) delay which is equal to the watchdog time  $T_{WD}$  (typically 100 ms with an external resistor of 123 k $\Omega$  connected at R pin). The POR delay prevents repeated toggling of RES even if V<sub>IN</sub> and the INPUT voltage drops out and recovers. The POR delay allows the microprocessor's crystal oscillator time to start and stabilize and ensures correct recognition of the reset signal to the microprocessor.

The RES output goes active low generating the power-down reset whenever  $V_{\mbox{\scriptsize IN}}$  falls below  $V_{\mbox{\scriptsize REF}}$  . The sensitivity or reaction time of the internal comparator to the voltage level on  $V_{IN}$  is typically 5  $\mu$ s.

#### **Timer Programming**

The on-chip oscillator with an external resistor REXT connected between the R pin and  $V_{ss}$  (see Fig. 8) allows the user to adjust the power-on reset (POR) delay, watchdog time T<sub>WD</sub> and with this also the closed and open time windows as well as the watchdog reset pulse width  $(T_{WD} / 40)$ . With  $R_{EXT} = 123 \text{ k}\Omega$  typical values are:

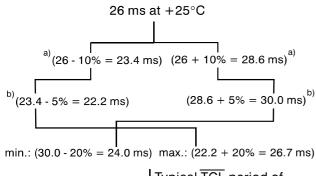
- Power-on reset delay:  $T_{POR} = 100 \text{ ms}$
- $T_{WD} = 100 \text{ ms}$ - Watchdog time:
- $T_{CW} = 80 \text{ ms}$  $T_{OW} = 40 \text{ ms}$ - Closed window:
- Open window:
- $T_{WDR} = 2.5 \text{ ms}$ - Watchdog reset:

Note the current consumption increases as the frequency increases.



#### Watchdog Timeout Period Description

The watchdog timeout period is divided into two parts, a "closed" window and an "open" window (see Fig. 3) and is defined by two parameters,  $T_{WD}$  and the Open Window Percentage (OWP).The closed window starts just after the watchdog timer resets and is defined by  $T_{CW} = T_{WD}$  - OWP( $T_{WD}$ ).The open window starts after the closed time window finishes and lasts till  $T_{WD}$  + OWP( $T_{WD}$ ). The open window time is defined by  $T_{OW} = 2 \times OWP(T_{WD})$ .



Typical TCL period of (24.0 + 26.7) / 2 = 25.4 ms

R

R

 $= 10 M\Omega^{2}$ 

= 1 MΩ

 $R = 100 \text{ k}\Omega$ 

 $R = 10 k\Omega$ 

 $R = 1 k\Omega$ 

6

Fig. 8

5

For example if  $T_{WD} = 100 \text{ ms}$  (actual value) and OWP =  $\pm$  20% this means the closed window lasts during first the 80 ms ( $T_{CW} = 80 \text{ ms} = 100 \text{ ms} - 0.2 (100 \text{ ms})$ ) and the open window the next 40 ms ( $T_{OW} = 2 \times 0.2 (100 \text{ ms}) = 40 \text{ ms}$ ). The watchdog can be serviced between 80 ms and

 $T_{wD}$  versus  $V_{OUTPUT}$  at  $T_J = +25 \ ^{\circ}C$ 

120 ms after the timer reset. However as the time base is  $\pm 10\%$  accurate, software must use the following calculation for servicing signal TCL during the open window:

Related to curves (Fig. 10 to Fig. 20), especially Fig. 19 and Fig. 20, the relation between  $T_{WD}$  and  $R_{EXT}$  could easily be defined. Let us take an example describing the variations due to production and temperature:

- 1. Choice,  $T_{WD} = 26$  ms.
- 2. Related to Fig. 20, the coefficient ( $T_{wD}$  to  $R_{EXT}$ ) is 1.125 where  $R_{EXT}$  is in  $k\Omega$  and  $T_{wD}$  in ms.
- 3.  $R_{EXT}$  (typ.) = 26 x 1.155 = 30.0 k $\Omega$ .
- 4. The ratio between  $T_{WD} = 26$  ms and the (TCL period) = 25.4 ms is 0.975. Then the relation over the Production and the full temperature range is,

ICL period = 
$$0.975 \times I_{WD} 0.975 \times R_{EXT}$$
 or

 $\overline{\text{TCL}} \text{ period} = \frac{0.975 \text{ x R}_{\text{EXT}}}{1.155}$ , as typical value.

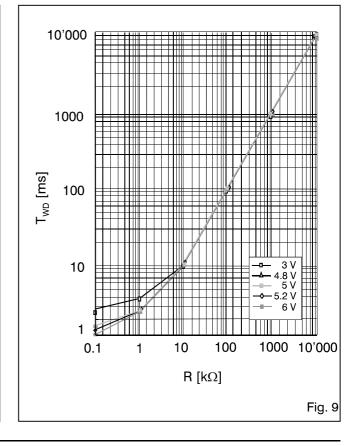
- a)  $\pm 10$  % while PRODUCTION value unknown for the customer when  $R_{EXT} \neq 123$  k $\Omega$ .
- b)  $\pm 5$  % while operating TEMPERATURE range  $-40^{\circ}C \le T_{J} \le +125^{\circ}C$ .

5. If you fixed a TCL period = 26 ms  

$$\Rightarrow R_{EXT} \quad \frac{26 \times 1.155}{0.975} = 30.8 \text{ k}\Omega.$$

 $T_{WD}$  versus R at  $T_J = +25 \degree C$ 

If during your production the  $T_{WD}$  time can be measured at  $T_J = +25^{\circ}C$  and the  $\mu$ C can adjust the TCL period, then the TCL period range will be much larger for the full operating temperature.



10'000

1'000

100

10

1

3

4

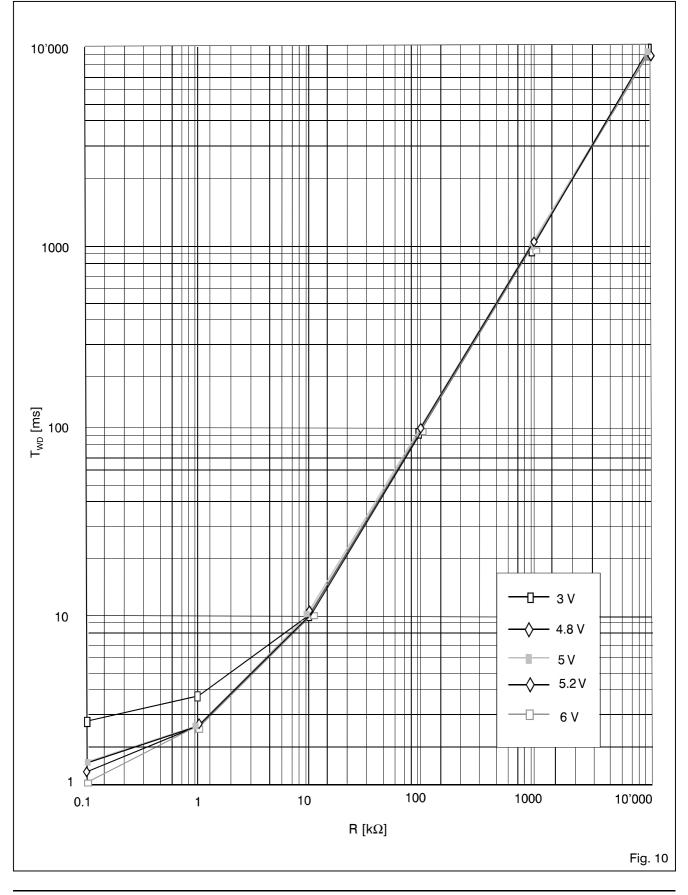
VOUTPUT [V]

T<sub>wb</sub> [ms]



A6250

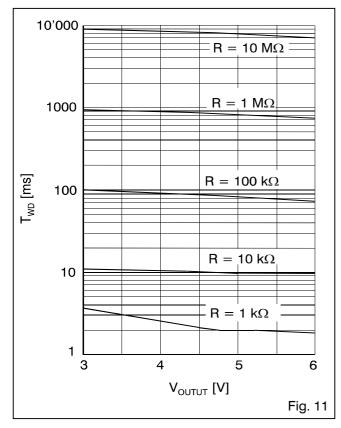
### $T_{WD}$ versus R at $T_J = +25 \ ^{\circ}C$



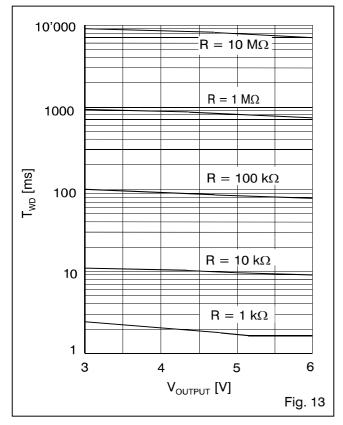




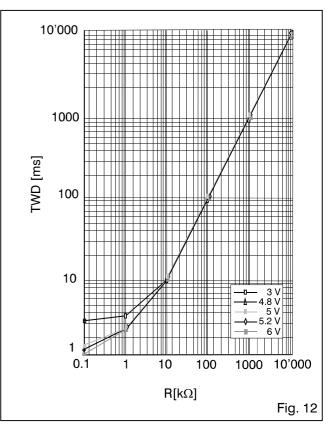




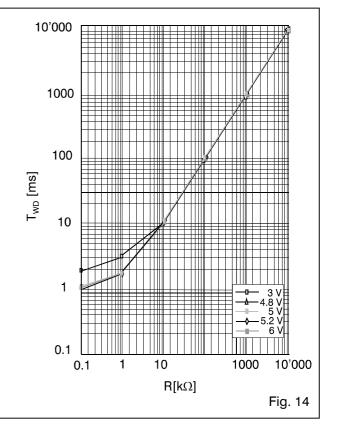




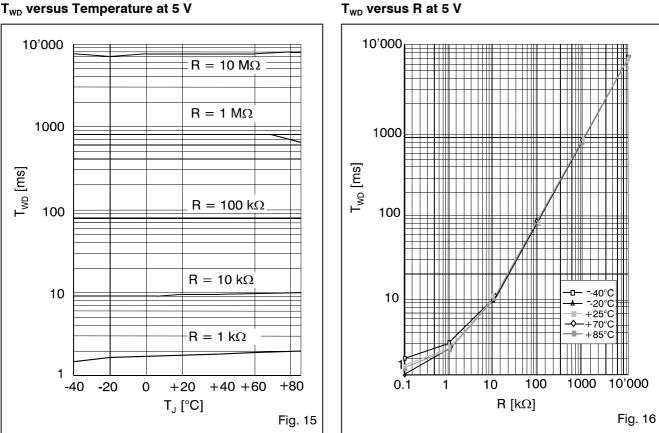
 $T_{w \scriptscriptstyle D}$  versus R at  $T_{\scriptscriptstyle J}=\,+85~^\circ C$ 



 $T_{WD}$  versus R at  $T_J = -40^{\circ}C$ 

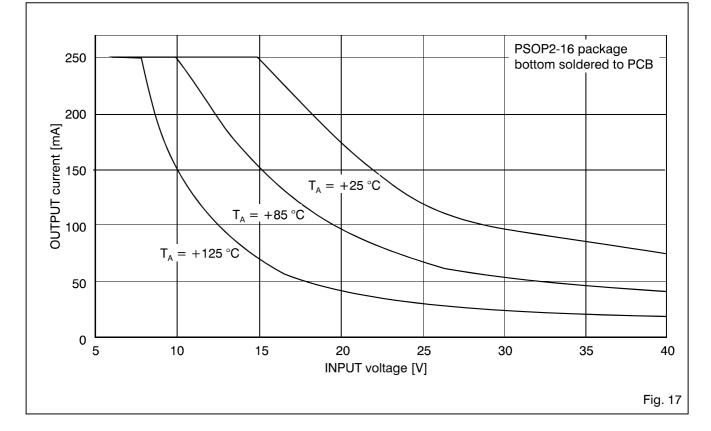






TwD versus Temperature at 5 V

Maximum OUTPUT Current versus INPUT Voltage





#### Timer Clearing and RES Action

The watchdog circuit monitors the activity of the processor. If the user's software does not send a pulse to the TCL input within the programmed open window timeout period a short watchdog RES pulse is generated which is equal to  $T_{WD}$  / 40 = 2.5 ms typically (see Fig. 5). With the open window constraint new security is added to conventional watchdogs by monitoring both software cycle time and execution. Should software clear the watchdog too quickly (incorrect cycle time) or too slowly (incorrect execution) it will cause the system to be reset. If software is stuck in a loop which includes the routine to clear the watchdog then a conventional watchdog would not make a system reset even though software is malfunctioning; the A6250 would make a system reset because the watchdog would be cleared too quickly. If no TCL signal is applied before the closed and open windows expire, RES will start to generate square waves of period (T<sub>cw</sub> + T<sub>ow</sub> +  $T_{WDR}$ ). The watchdog will remain in this state until the next TCL falling edge appears during an open window, or until a fresh power-up sequence. The system enable output, EN, can be used to prevent critical control functions being activated in the event of the system going into this failure mode (see section "Enable - EN Output"). The RES output must be pulled up to VOUTPUT even if the output is not used by the system (see Fig. 8).

#### **Combined Voltage and Timer Action**

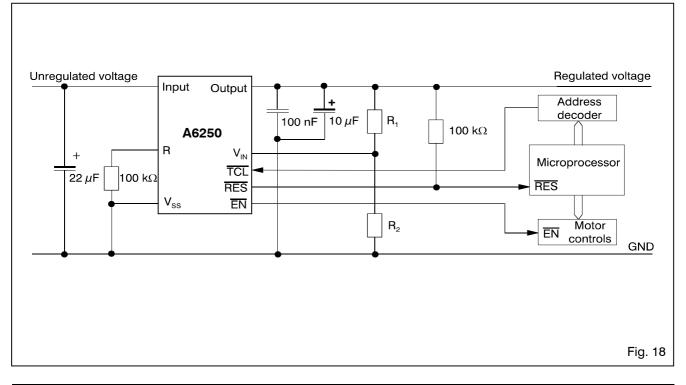
The combination of voltage and timer actions is illustrated by the sequence of events shown in Fig. 6. On power-up, when the voltage at  $V_{IN}$  reaches  $V_{REP}$  the power-on-reset, POR, delay is initialized and holds RES active for the time

# A6250

of the POR delay. A TCL pulse will have no effect until this power-on-reset delay is completed. After the POR delay has elapsed, RES goes inactive and the watchdog timer starts acting. If no TCL pulse occurs, RES goes active low for a short time T<sub>WDR</sub> after each closed and open window period. A TCL pulse coming during the open window clears the watchdog timer. When the TCL pulse occurs too early (during the closed window), RES goes active and a new timeout sequence starts. A voltage drop below the V<sub>REF</sub> level for longer than typically 5  $\mu$ s overrides the timer and immediately forces RES active and EN inactive. Any further TCL pulse has no effect until the next power-up sequence has completed.

#### Enable - EN Output

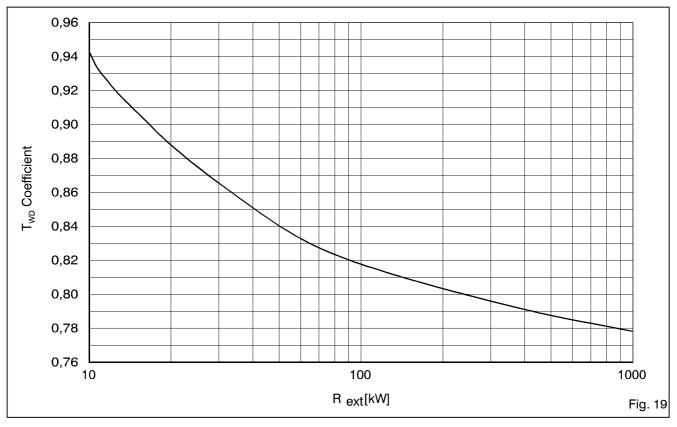
The system enable output, EN, is inactive always when RES is active and remains inactive after a RES pulse until the watchdog is serviced correctly 3 consecutive times (ie. the TCL pulse must come in the open window). After three consecutive services of the watchdog with TCL during the open window, the EN goes active low. A malfunctioning system would be repeatedly reset by the watchdog. In a conventional system critical motor controls could be energized each time reset goes inactive (time allowed for the system to restart) and in this way the electrical motors driven by the system could function out of control. The A6250 prevents the above failure mode by using the EN output to disable the motor controls until software has successfully cleared the watchdog three times (ie. the system has correctly restarted after a reset condition).



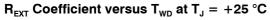
## **Typical Application**

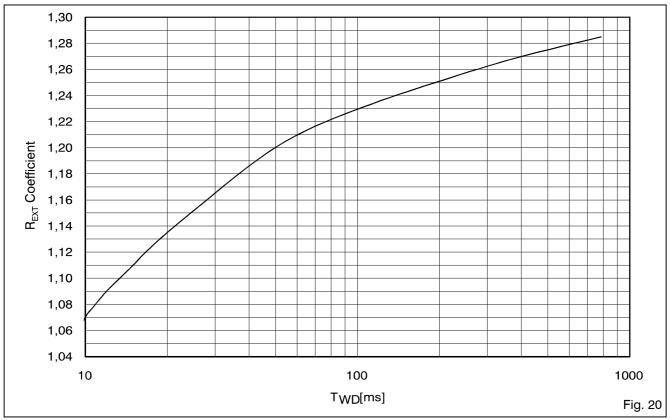


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### $T_{w \scriptscriptstyle D}$ Coefficient versus $R_{\scriptscriptstyle EXT}$ at $T_{\scriptscriptstyle J}$ = +25 $^\circ C$

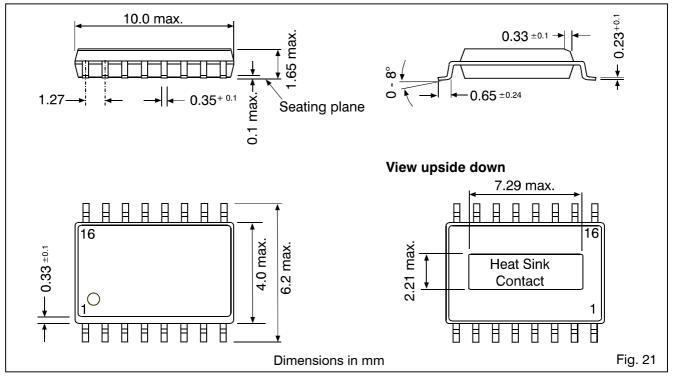




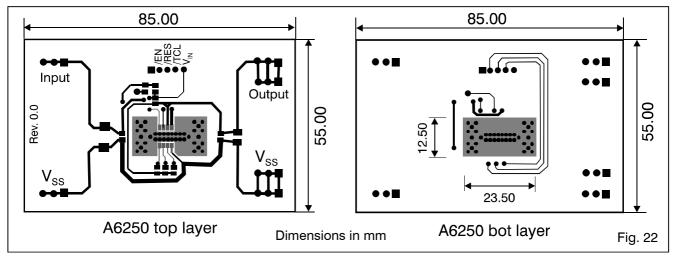


### Package and Ordering Information

#### **Dimensions of PSOP2-16 Package**



#### **Dual Layer PCB**



#### **Ordering Information**

The A6250 is available in the following package:

Type Package

A6250 X 16W PSOP2-16

When ordering please specify complete part number.

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